





COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON)}	I _D T _A = +25°C
35V	35mΩ @ V _{GS} = 10V	13A
-35V	45mΩ @ V _{GS} = -10V	-12A

Description

This new generation MOSFET has been designed to minimize the onstate resistance ($R_{DS(on)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Backlighting
- DC-DC Converters
- Power management functions

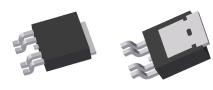
Features and Benefits

- 0.6mm profile ideal for low profile applications
- PCB footprint of 4mm²
- Low Gate Threshold Voltage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

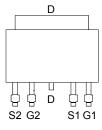
- Case: TO252-4L
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (23)
- Weight: 0.328 grams (approximate)

TO252-4L





Bottom View



Pinout Top view



N-Channel MOSFET



P-Channel MOSFET

Ordering Information (Note 3)

Part Number	Case	Packaging
DMG4511SK4-7	TO252-4L	3000 / Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



⊃¦¦ = Manufacturer's Marking G4511S = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 09 = 2009) WW = Week (01 – 53)



Maximum Ratings - N-CHANNEL, Q1 (@T_A = +25°C, unless otherwise specified.)

Characteris	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	35	V		
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 5) V _{GS} = 10V	Steady State	T _A = +25°C T _A = +70°C	I _D	5.3 4.2	А
Continuous Drain Current (Note 6) V _{GS} = 10V	Steady State	T _A = +25°C T _A = +70°C	I _D	8.6 6.8	Α
Continuous Drain Current (Note 6) V _{GS} = 10V	t ≤ 10s	T _A = +25°C T _A = +70°C	I _D	13 11	Α
Continuous Drain Current (Note 6) V _{GS} = 4.5V	Steady State	T _A = +25°C T _A = +70°C	I _D	6.3 5.0	Α
Continuous Drain Current (Note 6) V _{GS} = 4.5V	t ≤ 10s	T _A =+ 25°C T _A = +70°C	I _D	9.3 7.4	Α
Pulsed Drain Current (Note 7)	I _{DM}	50	А		

Maximum Ratings – P-CHANNEL, Q2 (@T_A = +25°C, unless otherwise specified.)

Characteris	Symbol	Value	Unit		
Drain-Source Voltage	V_{DSS}	-35	V		
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 5) V _{GS} = -10V	Steady State	T _A = +25°C T _A = +70°C	I _D	-5.0 -3.8	А
Continuous Drain Current (Note 6) V _{GS} = -10V	Steady State	T _A = +25°C T _A = +70°C	I _D	-7.8 -6.2	А
Continuous Drain Current (Note 6) V _{GS} = -10V	t ≤ 10s	T _A = +25°C T _A = +70°C	I _D	-12 -10	А
Continuous Drain Current (Note 6) V _{GS} = -4.5V	Steady State	T _A = +25°C T _A = +70°C	I _D	-6.5 -5.2	А
Continuous Drain Current (Note 6) V _{GS} = -4.5V	t ≤ 10s	T _A = +25°C T _A = +70°C	I _D	-9.6 -7.7	А
Pulsed Drain Current (Note 7)	I _{DM}	-50	Α		

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P _D	1.54	W
Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 5)	R _{0JA}	81.3	°C/W
Power Dissipation (Note 6)	P _D	4.1	W
Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 6)	$R_{ heta JA}$	30.8	°C/W
Power Dissipation (Note 6) t ≤ 10s	P _D	8.9	W
Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 5) t ≤ 10s	$R_{ heta JA}$	14	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Notes:

- 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate
- 7. I_{AS} and E_{AS} rating are based on low frequency and duty cycles to keep T_J = +25°C
- 8. Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to product testing.



Electrical Characteristics – N-CHANNEL, Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV_DSS	35	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	l		1.0	μΑ	V _{DS} = 35V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}		_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	$V_{GS(th)}$	1.0		3.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
Static Drain-Source On-Resistance	J		25	35	mΩ	$V_{GS} = 10V, I_D = 8A$
Static Drain-Source On-Resistance	R _{DS (ON)}		50	65	11122	$V_{GS} = 4.5V, I_D = 6A$
Forward Transfer Admittance	Y _{fs}		4.5	_	S	$V_{DS} = 10V, I_{D} = 8A$
Diode Forward Voltage	V_{SD}	_	_	1.2	V	$V_{GS} = 0V, I_{S} = 8A$
DYNAMIC CHARACTERISTICS (Note 9)			-	-		
Input Capacitance	C _{iss}	1	850	_	pF	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\
Output Capacitance	Coss	_	64.7	_	pF	$V_{DS} = 25V, V_{GS} = 0V,$ -f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}		51.9	_	pF	1 - 1.0Wi 12
Gate Resistance	R_{g}		1.6	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (V _{GS} = 10V)	Qg	_	18.7	_		$V_{GS} = 10V, V_{DS} = 28V, I_D = 8A$
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	8.8	_	~C	V _{GS} = 4.5V, V _{DS} = 28V,
Gate-Source Charge	Qgs	_	2.6	_	nC	
Gate-Drain Charge	Q _{qd}	_	2.1	_		I _D = 8A
Turn-On Delay Time	t _{D(on)}	_	5.4	_	ns	
Turn-On Rise Time	t _r		2.8	_	ns	$V_{DS} = 18V, V_{GS} = 10V,$
Turn-Off Delay Time	t _{D(off)}		33.2	_	ns	$R_L = 18\Omega, R_G = 3.3\Omega,$
Turn-Off Fall Time	t _f	_	35.6	_	ns	-I _D = 1A

Electrical Characteristics – P-CHANNEL, Q2 (@T_A = +25°C, unless otherwise specified.)

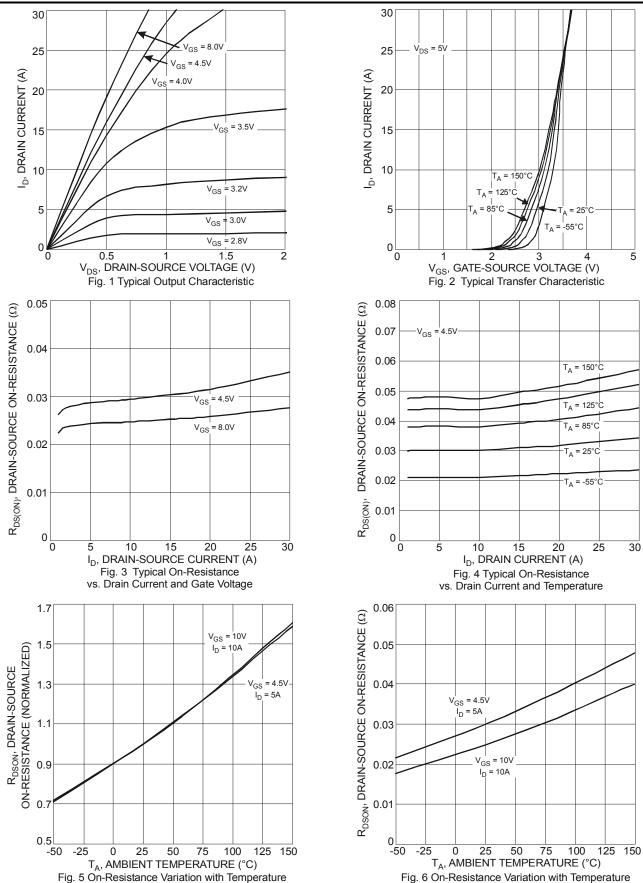
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)					•	•
Drain-Source Breakdown Voltage	BV _{DSS}	-35	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current T _J = 25°C	I _{DSS}	_	_	-1.0	μΑ	$V_{DS} = -35V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(th)}	-1.0	_	-3.0	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
Static Drain-Source On-Resistance	D		30	45	mΩ	$V_{GS} = -10V, I_D = -6A$
Static Dialii-Source Off-Resistance	R _{DS (ON)}	_	40	65	11122	$V_{GS} = -4.5V$, $I_{D} = -4A$
Forward Transfer Admittance	Y _{fs}	_	8	_	S	$V_{DS} = -10V, I_{D} = -6A$
Diode Forward Voltage	V _{SD}	_	_	-1.2	V	$V_{GS} = 0V, I_{S} = -6A$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	C _{iss}	_	985.2	_	pF	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\
Output Capacitance	Coss	_	90.6	_	pF	V _{DS} = -25V, V _{GS} = 0V, -f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	_	75.3	_	pF	1 - 1:0W112
Gate Resistance	R_{g}	_	7.0	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (V _{GS} = -10V)	Qg	_	19.2	_		$V_{GS} = -10V$, $V_{DS} = -28V$, $I_{D} = -6A$
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	9.5	_	nC	V _{GS} = -4.5V, V _{DS} = -28V,
Gate-Source Charge	Q_{gs}	_	2.0	_	IIC	
Gate-Drain Charge	Q_{gd}	_	3.5	_		$I_D = -6A$
Turn-On Delay Time	t _{D(on)}	_	5.2	_	ns	10/1/
Turn-On Rise Time	t _r	_	4.8	_	ns	$V_{DS} = -18V, V_{GS} = -10V,$
Turn-Off Delay Time	t _{D(off)}	_	45.8	_	ns	$R_L = 18\Omega, R_G = 3.3\Omega,$ $I_D = -1A$
Turn-Off Fall Time	t _f	_	29.5	_	ns	71D 1A

Notes: 8. Short duration pulse test used to minimize self-heating effect.

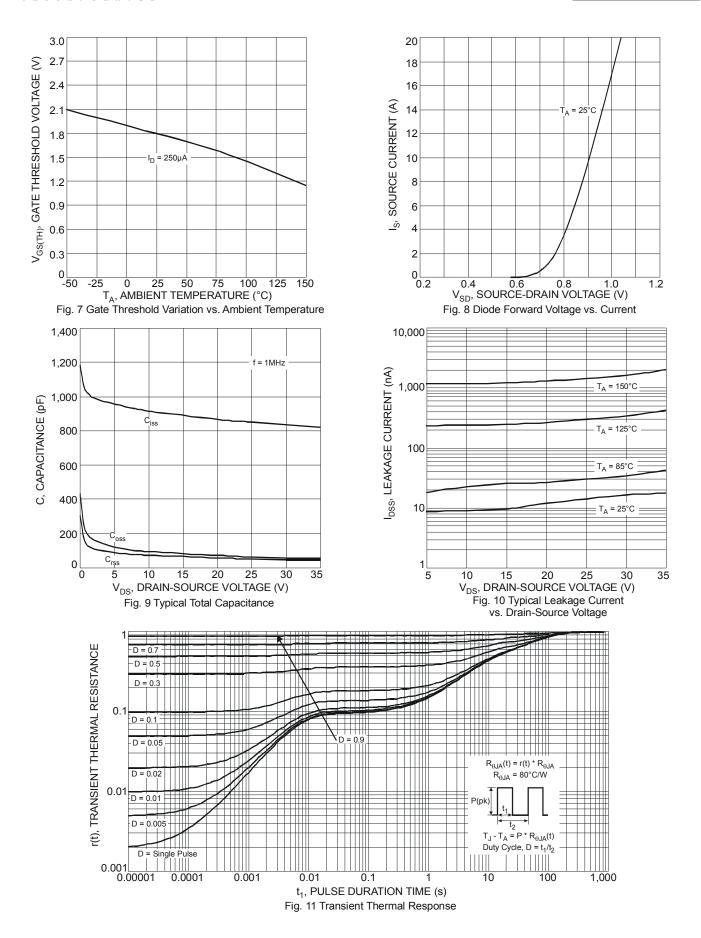
^{9.} Guaranteed by design. Not subject to product testing.



N-CHANNEL, Q1









P-CHANNEL, Q2

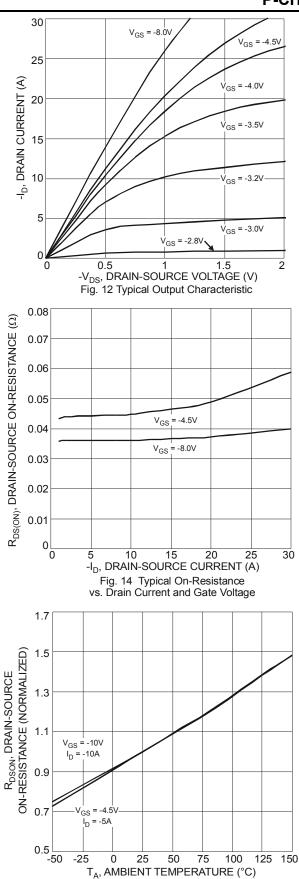
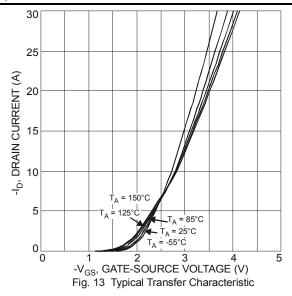
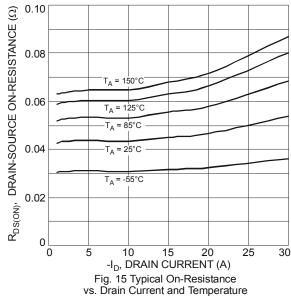


Fig. 16 On-Resistance Variation with Temperature





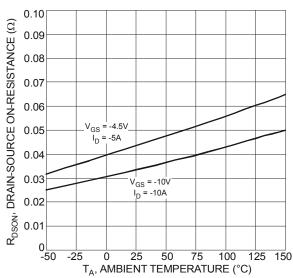
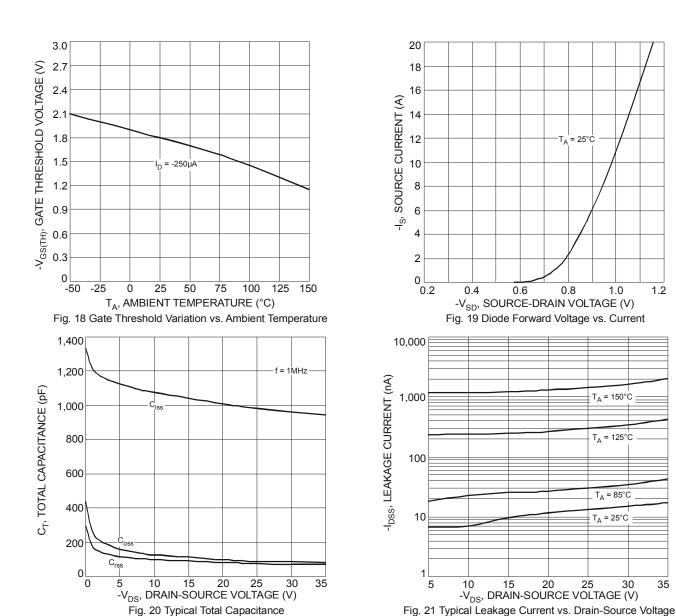


Fig. 17 On-Resistance Variation with Temperature

1.2

35



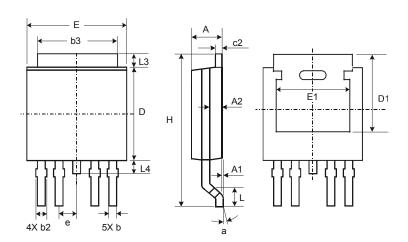


r(t), TRANSIENT THERMAL RESISTANCE - D = 0.5 D = 0.3 D = 0.1 D = 0.9 -D = 0.05 $R_{\theta JA} = 80^{\circ}C/W$ 0.01 D = 0.01 $T_J - T_A = P * R_{\theta JA}(t)$ Duty Cycle, $D = t_1/t_2$ 0.001 $\begin{array}{ccc} 0.01 & 0.1 & 1 \\ t_1, \text{ PULSE DURATION TIME (s)} \end{array}$ 0.00001 0.0001 0.001 10 100 1,000



Package Outline Dimensions

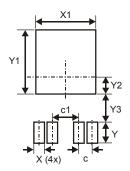
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



	TO252-4L						
Dim	Min	Max	Тур				
Α	2.19	2.39	2.29				
A1	0.00	0.13	0.08				
A2	0.97	1.17	1.07				
b	0.51	0.71	0.583				
b2	0.61	0.79	0.70				
b3	5.21	5.46	5.33				
c2	0.45	0.58	0.531				
D	6.00	6.20	6.10				
D1	5.21	_	_				
е	_	_	1.27				
Е	6.45	6.70	6.58				
E1	4.32	_	_				
Н	9.40	10.41	9.91				
L	1.40	1.78	1.59				
L3	0.88	1.27	1.08				
L4	0.64	1.02	0.83				
а	0°	10°	_				
All Dimensions in mm							

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	1.27
c1	2.54
X	1.00
X1	5.73
Υ	2.00
Y1	6.17
Y2	1.64
Y3	2.66



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